

INNOV 2017

Committee

INNOV Steering Committee

Yu-Chen Hu, Providence University, Taiwan
Carlos Becker Westphall, University of Santa Catarina, Brazil
Shih-Chang Huang, National Formosa University, Taiwan
Kiriakos Patriarcheas, Hellenic Open University, Greece
Jaime Lloret Mauri, Universitat Politècnica de València, Spain

INNOV Industry/Research Advisory Committee

Igor Kotenko, ITMO University and Russian Academy of Sciences (SPIIRAS), Russia
Sung-soon Park, Anyang University and Gluesys Co. LTD, Republic of Korea
Binod Kumar, JSPM Jayawant Institute of Computer Applications, Pune, India

INNOV 2017 Technical Program Committee

Carlos Becker Westphall, University of Santa Catarina, Brazil
Eugen Borcoci, University "Politehnica" of Bucharest (UPB), Romania
YK Chang, National Cheng Kung University, Taiwan
Albert M. K. Cheng, University of Houston, USA
Salimur Choudhury, Algoma University, Canada
Sanjay Dwivedi, Babasaheb Bhimrao Ambedkar University, India
Panagiotis Fouliras, University of Macedonia, Thessaloniki, Greece
Marco Furini, University of Modena and Reggio Emilia, Italy
Houcine Hassan, Universitat Politècnica de Valencia, Spain
Qiang (Nathan) He, Swinburne University of Technology, Australia
Yu-Chen Hu, Providence University, Taiwan
Kuo-Chan Huang, National Taichung University of Education, Taiwan
Shih-Chang Huang, National Formosa University, Taiwan
Wen-Jyi Hwang, National Taiwan Normal University, Taiwan
Sergio Ilarri, University of Zaragoza, Spain
Yiming Ji, University of South Carolina Beaufort, USA
Eugene B. John, The University of Texas at San Antonio, USA
Alexandros Kaloxylas, University of Peloponnese, Greece
Alexey M. Kashevnik, St. Petersburg Institute for Informatics and Automation of the Russian Academy of Sciences (SPIIRAS), Russia
Toshihiko Kato, University of Electro-Communications, Japan
Khaled Khankan, Taibah University, Saudi Arabia
Hyunju Kim, Wheaton College, USA
Igor Kotenko, ITMO University and Russian Academy of Sciences (SPIIRAS), Russia
Katina Kravlevska, Norwegian University of Science and Technology - NTNU, Norway
Silvia Krug, IMMS - Institute for Microelectronic and Mechatronic Systems, Ilmenau, Germany
Binod Kumar, JSPM Jayawant Institute of Computer Applications, Pune, India

Valderi Leithardt, University of Vale do Itajai – Univali, Brazil
Yiu-Wing Leung, Hong Kong Baptist University, Kowloon Tong, Hong Kong
Chanjuan Liu, Dalian University of Technology, China
Zhi Liu, University of North Texas, USA
Jaime Lloret Mauri, Universitat Politècnica de València, Spain
René Meier, Lucerne University of Applied Sciences and Arts, Switzerland
Amalia Miliou, Aristotle University of Thessaloniki, Greece
Suresh Muknahallipatna, University of Wyoming, USA
Gianfranco Nencioni, Norwegian University of Science and Technology (NTNU), Norway
Sung-soon Park, Anyang University and Gluesys Co. LTD, Republic of Korea
Kiriakos Patriarcheas, Hellenic Open University, Greece
Joao Paulo Carvalho, INESC-ID / Instituto Superior Técnico - Universidade de Lisboa, Portugal
Marcin Piotr Pawlowski, Jagiellonian University, Poland
Jose Javier Ramasco, IFISC (CSIC-UIB), Spain
Hendrik Richter, HTWK Leipzig University of Applied Sciences, Germany
Ounsa Roudies, Ecole Mohammadia d'Ingénieurs - Mohammed-V University in Rabat, Morocco
Fariba Sadri, Imperial College London, UK
Panagiotis Sarigiannidis, University of Western Macedonia, Greece
J. A. Tenreiro Machado, Institute of Engineering | Polytechnic of Porto, Portugal
Raquel Trillo Lado, University of Zaragoza, Spain
Óscar Urrea, University of Zaragoza, Spain
Mudasser F. Wyne, National University, USA
Cong-Cong Xing, Nicholls State University, USA
Xiao-Lei Zhang, Northwestern Polytechnical University, China